

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10788505			
<b>Filing Date:</b>	26-Feb-2004			
<b>Title of Invention:</b>	Thin profile battery bonding method, method of conductively interconnecting electronic components, battery powerable apparatus, radio frequency communication device, and electric circuit			
<b>First Named Inventor/Applicant Name:</b>	Rickie C. Lake			
<b>Filer:</b>	Lehua Wang/Anne Collette			
<b>Attorney Docket Number:</b>	076838-106703/US			
Filed as Large Entity				
<b>Utility under 35 USC 111(a) Filing Fees</b>				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
Statutory disclaimer	1814	1	140	140
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 1 month with \$0 paid	1251	1	130	130
Miscellaneous:				
Total in USD (\$)				270